

Processing/Physical Characteristics	dry / cond	Unit	Test Standard
ISO Data			
^[C] Molding shrinkage, parallel	0.5 / *	%	ISO 294-4, 2577
^[C] Molding shrinkage, normal	1.4 / *	%	ISO 294-4, 2577

[C]: CAMPUS

Mechanical properties	dry / cond	Unit	Test Standard
ISO Data			
^[C] Tensile Modulus	6200 / 4300	MPa	ISO 527
^[C] Stress at break	125 / 90	MPa	ISO 527
^[C] Strain at break	3 / 8	%	ISO 527
Flexural modulus, 23°C	5300 / 3500	MPa	ISO 178
Flexural strength	- / 115	MPa	ISO 178
^[C] Charpy impact strength, +23°C	40 / 65	kJ/m ²	ISO 179/1eU
^[C] Charpy notched impact strength, +23°C	5 / 6.5	kJ/m ²	ISO 179/1eA

[C]: CAMPUS

Thermal properties	dry / cond	Unit	Test Standard
ISO Data			
^[C] Melting temperature, 10°C/min	263 / *	°C	ISO 11357-1/-3
^[C] Temp. of deflection under load, 1.80 MPa	245 / *	°C	ISO 75-1/-2
^[C] Burning Behav. at thickness h	HB / *	class	IEC 60695-11-10
Thickness tested	3.0 / *	mm	-
Yellow Card available	yes / *	-	-

[C]: CAMPUS

Electrical properties	dry / cond	Unit	Test Standard
ISO Data			
^[C] Volume resistivity	1E13 / -	Ohm*m	IEC 62631-3-1
^[C] Surface resistivity	* / >1E15	Ohm	IEC 62631-3-2
^[C] Electric strength	31 / -	kV/mm	IEC 60243-1
^[C] Comparative tracking index	400 / -	-	IEC 60112

[C]: CAMPUS

Other properties	dry / cond	Unit	Test Standard
^[C] Density	1240 / -	kg/m ³	ISO 1183

[C]: CAMPUS

Characteristics

Processing

Injection Molding

Delivery form

Black

Special Characteristics

Heat stabilized or stable to heat

Applications

Electrical and Electronical